

**TWO-WIRE AUTOMOTIVE HALL EFFECT  
 UNIPOLAR / LATCH SWITCHES INTEGRATED SELF-DIAGNOSTICS**
**Description**

The AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are high voltage, high sensitivity two-wire Hall Effect Unipolar/Latch switch ICs with integrated self-diagnostics and automotive-compliant AEC-Q100 qualification; designed for position and proximity sensing in automotive applications, such as seat and seatbelt buckle, transmission actuator, gear position, wiper, door/trunk closure, etc.

To support a wide range of demanding applications, the AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are optimized to operate over a supply range of 2.7V to 27V. These features include a chopper-stabilized architecture and an internal bandgap regulator to provide temperature compensated supply for internal circuits. For robustness and protection, the device has built-in reverse blocking diode with a Zener clamp on the supply.

The built-in thermal protection also shuts down the chip if temperature rises to an abnormal value. This will automatically restart the chip once the junction temperature drops below the safe value.

For AH3241Q, AH3242Q, and AH3243Q 2-wire unipolar switches: when the flux density (south pole) exceeds  $B_{OP}$ , the supply current state is turned on (low or high). The output is held until a magnetic flux density falls below  $B_{RP}$ , causing output current to be turned off.

For AH3280Q, AH3281Q, and AH3282Q 2-wire latch switches: when the magnetic flux density is larger than  $B_{OP}$ , output current is turned on (high). The output state is held until a magnetic flux density reversal falls below  $B_{RP}$ , causing output current to be turned off (low).

**Features and Performance**

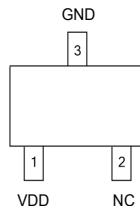
- Unipolar: AH3241Q, AH3242Q, AH3243Q
- Latch: AH3280Q, AH3281Q, AH3282Q
- Output Polarity:
  - Direct: AH3242Q, AH3243Q
  - Inverted: AH3241Q
- Wide Supply Voltage Operation: 2.7V to 27V
- Temperature Coefficient -1100ppm/°C (AH3242Q, AH3243Q)
- Chopper Stabilized Design Provides:
  - Superior Temperature Stability
  - Minimal Switch Point Drift
  - Enhanced Immunity to Stress
- Battery polarity reverse connection protection
- Transient Spike Voltage Protection
- Over-Temperature Shut Down and Auto-Restart
- UVLO Protection
- High ESD Rating: HBM = 8kV, CDM = 1kV
- Ready for ISO 26262
- Temperature Range: -40°C to +150°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1, 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The AH3241Q, AH3242Q, AH3243Q, AH3280Q, AH3281Q, and AH3282Q are suitable for automotive applications requiring specific change control; these parts are AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

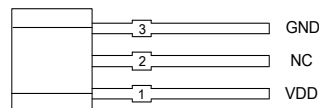
**Pin Assignments**

(Top View)



SC59 (Type A1)

(Top View)

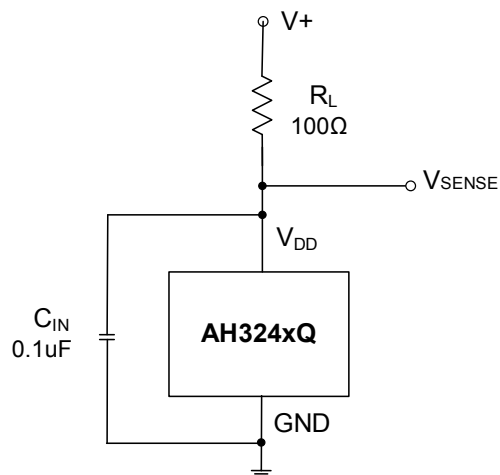


SIP-3 (Future Product)

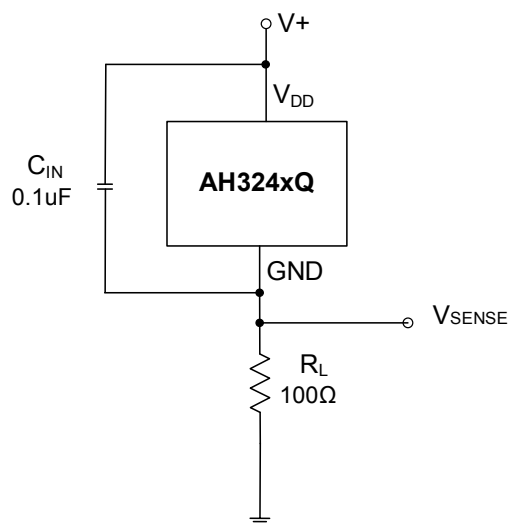
**Applications**

- Position and Proximity Sensing in Automotive Applications
- Seat position
- Seatbelt buckle
- Wiper position
- Window lifter
- Gear selection position

## Typical Applications Circuit



(1) High-side sensing



(2) Low-side sensing

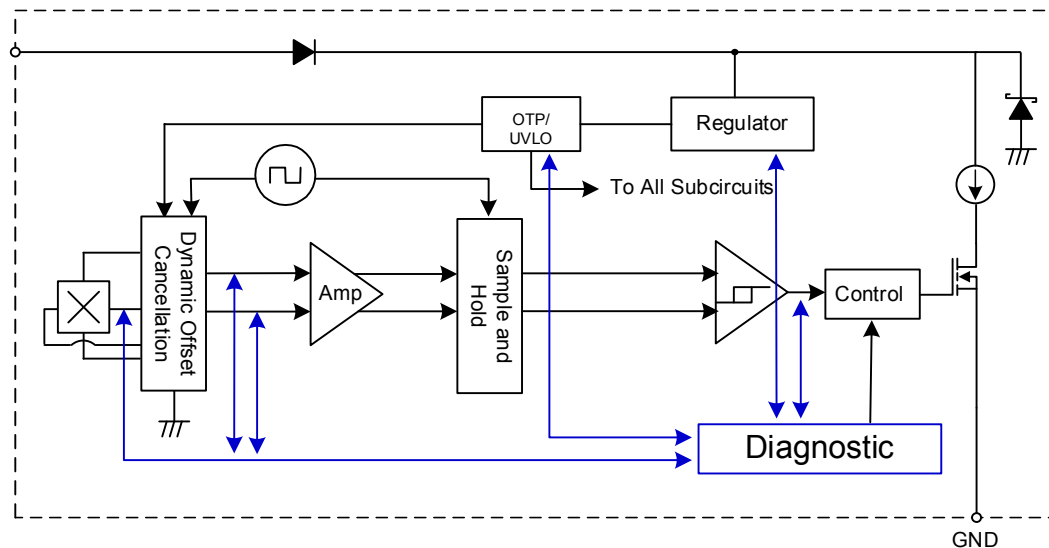
Note: 4. A 100nF or larger decoupling capacitor ( $C_{IN}$ ) between  $V_{DD}$  and GND pins is needed for power stabilization and to strengthen noise immunity;  $C_{IN}$  needs to be as close to IC as possible. Typical  $R_L$  value is 100Ω. Larger or additional series resistor is recommended if there are disturbances on  $V_{DD}$ .

## Pin Descriptions

Package: SC59 and SIP-3 (Ammo Pack and Bulk Pack)

Pin Number	Pin Name	Function
1	$V_{DD}$	Supply voltage input
2	NC	No connection; can be connected to $V_{DD}$ , GND, or left open.
3	GND	Ground

## Functional Block Diagram



**Absolute Maximum Ratings** (Note 5) (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V <sub>DD</sub> (Note 6)	Supply Voltage	32	V
V <sub>DDR</sub> (Note 6)	Reverse supply voltage	-32	V
B	Magnetic flux density	Unlimited	Gauss
T <sub>J_MAX</sub>	Maximum junction temperature	180	°C
T <sub>S</sub>	Storage Temperature	-55~180	°C
ESD (HBM)	ESD (Human Body Model)	8000	V
ESD (CDM)	ESD(Charged Device Model)	1000	V

Notes:

5. Stresses greater than the "Absolute Maximum Ratings" specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
6. Should not be exceeded the maximum junction temperature and maximum duration of 500ms.

**Recommended Operating Conditions** (@ T<sub>A</sub> = -40°C to +150°C, T<sub>J</sub> = -40°C to +165°C unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
V <sub>DD</sub>	Supply Voltage, between V <sub>DD</sub> and GND pins	2.7	27	V
T <sub>OP</sub>	Operating Ambient Temperature	-40	150	°C

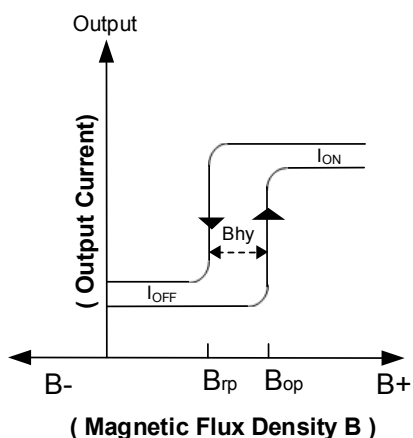
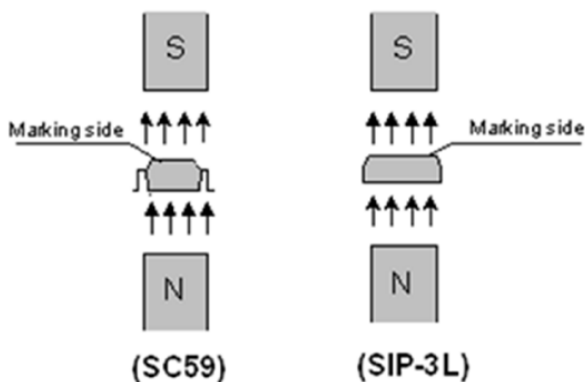
**Electrical Characteristics** (Note 7) (@  $T_A = -40^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$ ,  $T_J = -40^{\circ}\text{C}$  to  $+165^{\circ}\text{C}$ ,  $V_{DD} = 2.7\text{V}$  to  $27\text{V}$ , unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{DD}$	Supply voltage (Note 8)	-	2.7	12	27	V
$I_{OFF(2)}$	Supply current off state	$V_{DD} = 2.7$ to $27\text{V}$ (AH3280Q, AH3282Q)	2	3.3	5	mA
$I_{OFF(1)}$	Supply current off state	$V_{DD} = 2.7$ to $27\text{V}$ (AH3241Q, AH3242Q, AH3243Q, AH3281Q)	5	6	6.9	mA
$I_{ON}$	Supply current on state	$V_{DD} = 2.7$ to $27\text{V}$	12	14.5	17	mA
$V_{UVLO}$	Under voltage lockout threshold	Voltage dropping	-	2.2	2.7	V
$t_{UVLO}$	Under-voltage lockout reaction time	-	-	10	-	$\mu\text{s}$
$I_{DDR}$	Reverse supply current	$V_{DD} = -18\text{V}$ , $T = -40^{\circ}\text{C}$ to $+150^{\circ}\text{C}$	-1.5	-	-	mA
$T_{TP}$	Thermal protection threshold	Junction temperature	-	190	-	$^{\circ}\text{C}$
$T_{TPR}$	Thermal protection release threshold	Junction temperature	-	180	-	$^{\circ}\text{C}$
$F_M$	Maximum magnet switching frequency	$B > 3 \cdot B_{OP}$ , alternative square magnet field	30	50	-	kHz
$F_C$	Chopping frequency	-	-	1000	-	kHz
$I_{SAFE}$	Safe mode supply current	Safe mode supply current / Error Current (mA)	0.5	1	1.5	mA
$T_{PON}$	Power on delay time (Note 9)	$B > B_{OP} + 10\text{GS}$	-	28	40	$\mu\text{s}$
$T_D$	Response delay time (Note 10)	$B > 3 \cdot B_{OP}$	-	7	-	$\mu\text{s}$
$T_{RF}$	Current rise/fall time	$V_{DD} = 12\text{V}$ , No bypass capacitor, $C_{LOAD} = 50\text{pF}$ to GND	0.1	0.3	1	$\mu\text{s}$
POS	Power-Up State (Notes 9, 11)	$t > T_{PON}(\text{max})$ , $V_{DD}$ slew rate $> 1\text{V}/\mu\text{s}$	-	$I_{OFF}$	-	-
-	Output jitter	$B \geq 3 \cdot B_{OPMAX}$ 1000 successive square wave switching under 1KHz.-	-	$\pm 3.3$	-	$\mu\text{s}$

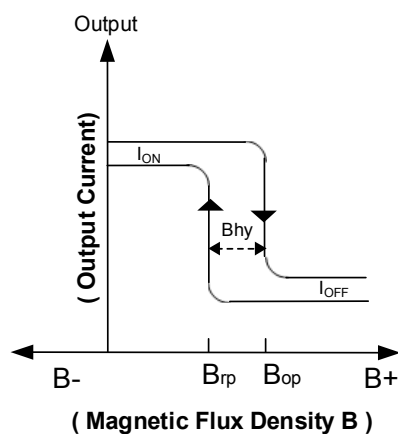
- Notes:
- Typical values are defined at  $T_A = +25^{\circ}\text{C}$ ,  $V_{DD} = 12\text{V}$ . Maximum and minimum values over the operating temperature range are not tested in production but guaranteed by design, process control and characterization.
  - $V_{DD}$  is the voltage between the VDD pin and the GND pin.
  - When power is initially turned on,  $V_{DD}$  must be operated in the correct voltage range to guarantee proper magnetic field sampling, output supply current state level is valid after the start up time of  $28\mu\text{s}$  from  $V_{DD}$  higher than  $2.7\text{V}$ . Guaranteed by design.
  - Time delayed from the magnetic threshold reached to the output rise or fall.
  - $t > T_{PON}$  and  $B_{RP} < B < B_{OP}$ .

**Magnetic Characteristics** (Notes 12, 13) ( $T_A = -40^\circ\text{C}$  to  $+150^\circ\text{C}$ ,  $T_J = -40^\circ\text{C}$  to  $+165^\circ\text{C}$ ,  $V_{DD} = 2.7\text{V}$  to  $27\text{V}$ , unless otherwise specified)

Part Name	Test Condition	Operating Point $B_{OP}$ (Gauss)			Release Point $B_{RP}$ (Gauss)			Temperature Coefficient (ppm/ $^\circ\text{C}$ )	$I_{OFF}$ (mA)	Active Pole	Output Polarity
		Min	Typ	Max	Min	Typ	Max	Typ			
AH3241Q	$T_A = 25^\circ\text{C}$	65	90	120	45	70	100	0	6	South	Inverted
	$T_A = -40 \sim 150^\circ\text{C}$	55	90	135	35	70	115				
AH3242Q	$T_A = 25^\circ\text{C}$	40	60	80	20	40	60	-1100	6	South	Direct
	$T_A = -40 \sim 150^\circ\text{C}$	30	60	90	10	40	70				
AH3243Q	$T_A = 25^\circ\text{C}$	27	45	63	10	28	46	-1100	6	South	Direct
	$T_A = -40 \sim 150^\circ\text{C}$	20	45	70	3	28	53				
AH3280Q	$T_A = 25^\circ\text{C}$	8	18	28	-28	-18	-8	0	3.3	South	Direct
	$T_A = -40 \sim 150^\circ\text{C}$	3	18	33	-33	-18	-3				
AH3281Q	$T_A = 25^\circ\text{C}$	8	18	28	-28	-18	-8	0	6	South	Direct
	$T_A = -40 \sim 150^\circ\text{C}$	3	18	33	-33	-18	-3				
AH3282Q	$T_A = 25^\circ\text{C}$	15	30	45	-45	-30	-15	0	3.3	South	Direct
	$T_A = -40 \sim 150^\circ\text{C}$	10	30	50	-50	-30	-10				



1) Direct South Pole Active

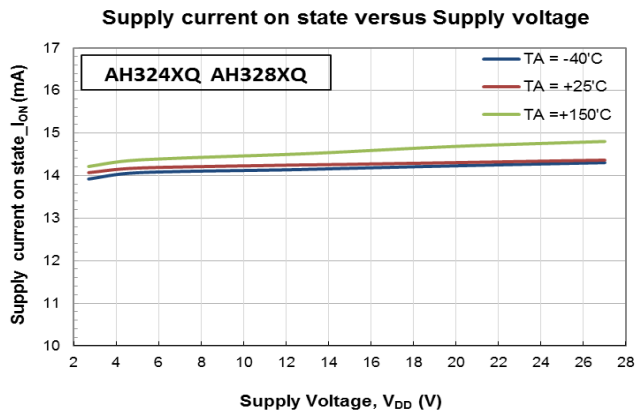
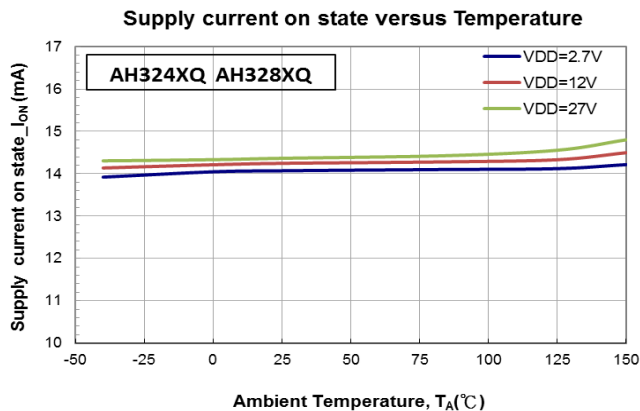


2) Inverted South Pole Active

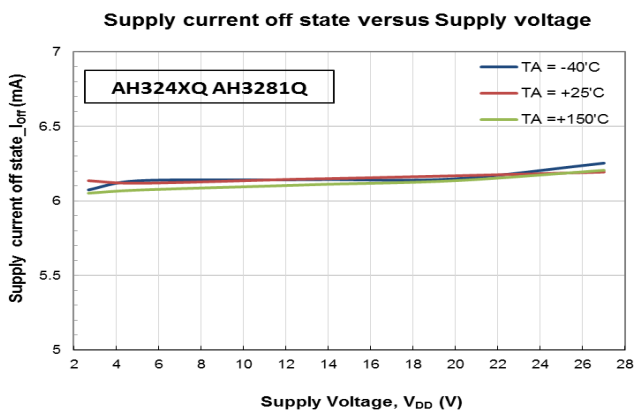
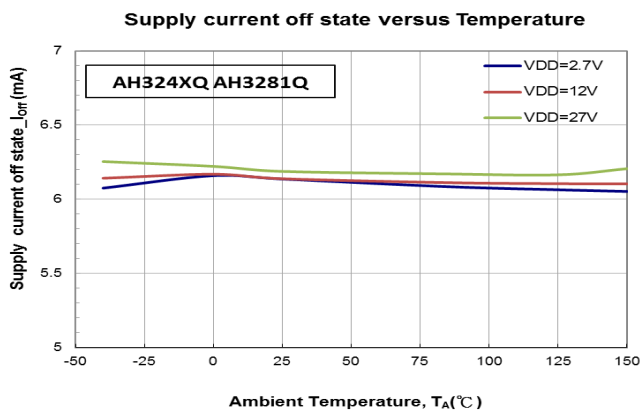
- Notes:
12. Positive x-axis direction indicates the South Pole approaching the part marking surface of SIP3 and SC59 i.e. increasing south pole magnetic field strength to the sensor; reversing direction x-axis toward 0 means the decreasing south magnetic field strength to the sensor. Negative x-axis indicates north pole magnetic field to the part marking surface.
  13. Typical values are defined at  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 12\text{V}$ . Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization.

## Typical Operating Characteristics

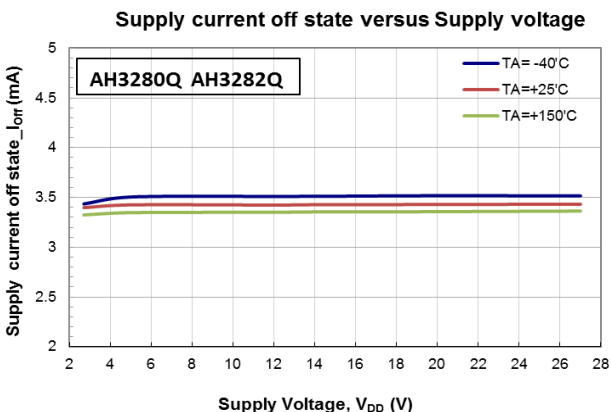
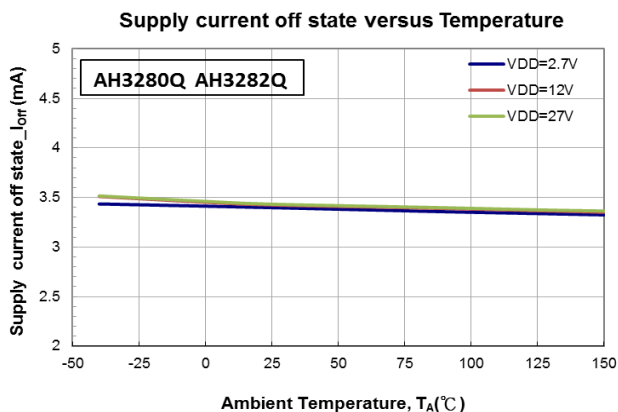
### AH324XQ\_AH328XQ Supply Current ON, $I_{ON}$ Performance



### AH324XQ\_AH3281Q Supply Current OFF, $I_{OFF(1)}$ Performance

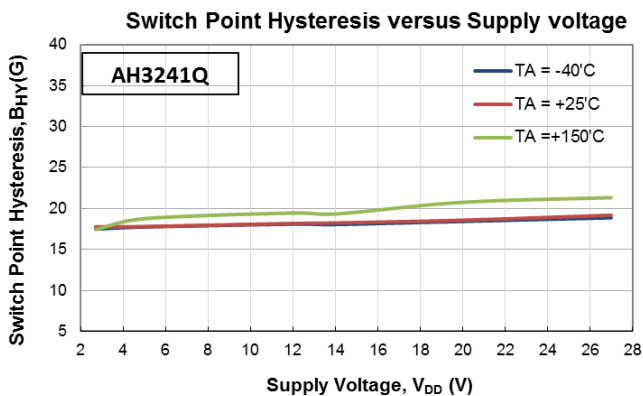
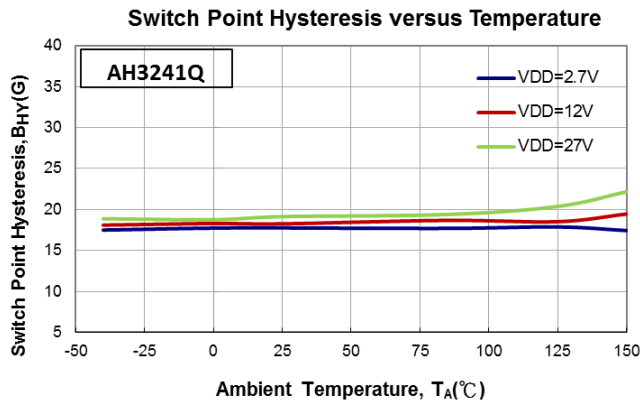
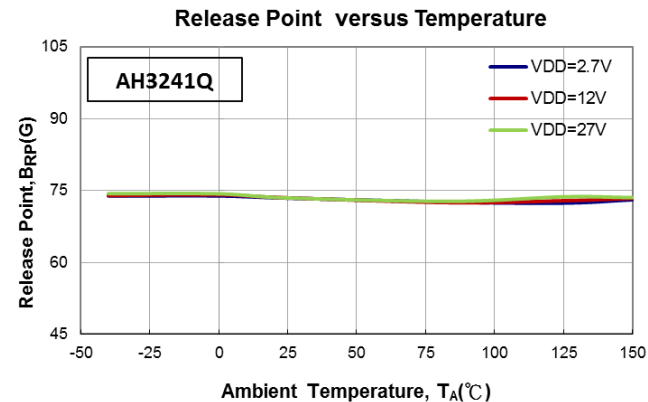
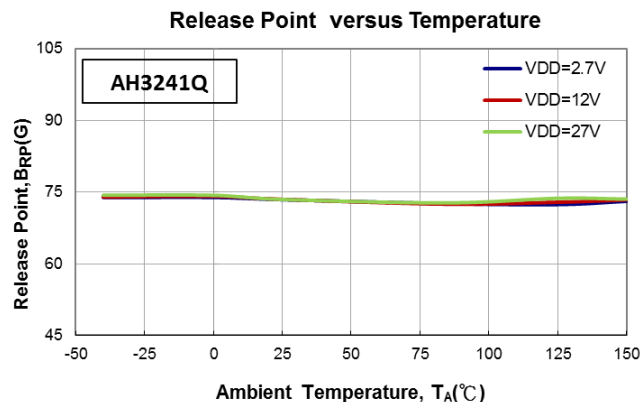
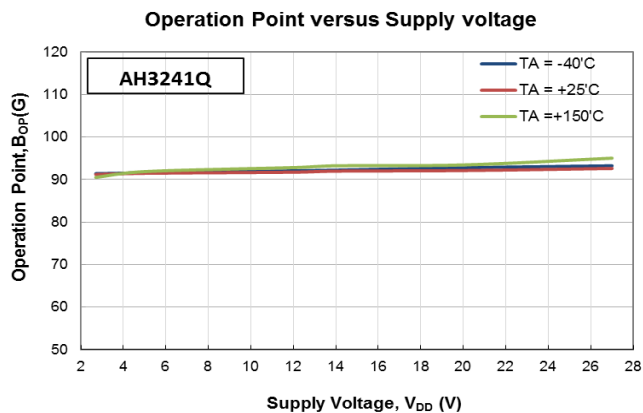
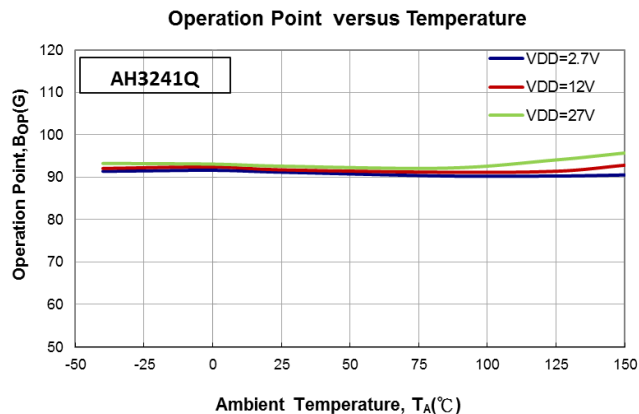


### AH3280Q\_AH3282Q Supply Current OFF, $I_{OFF(2)}$ Performance



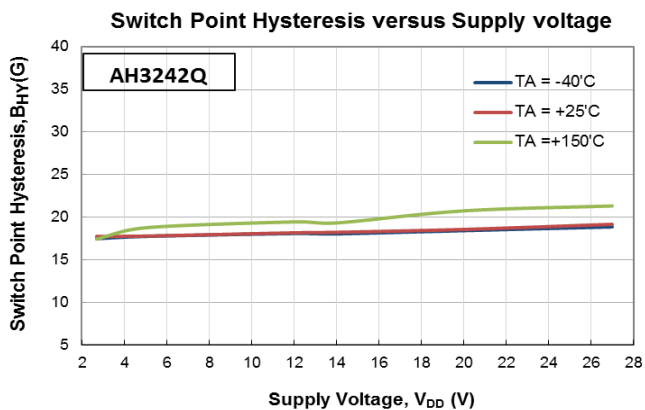
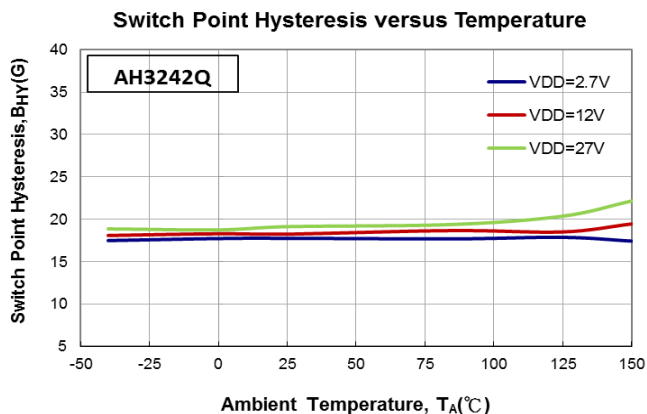
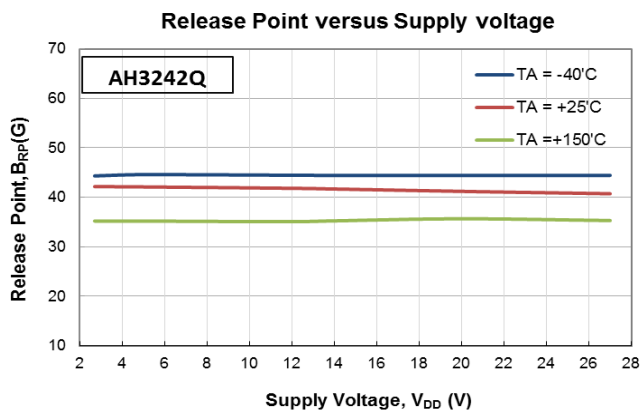
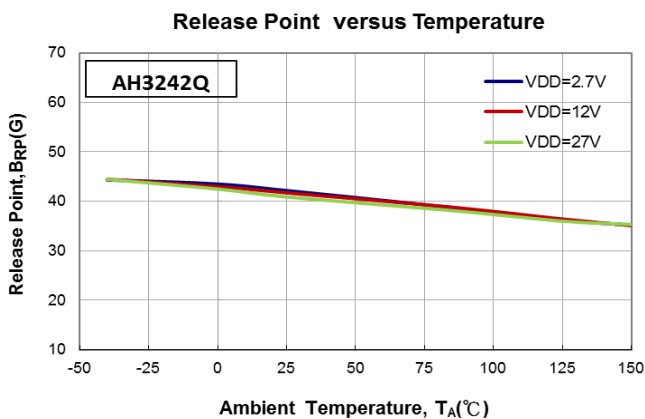
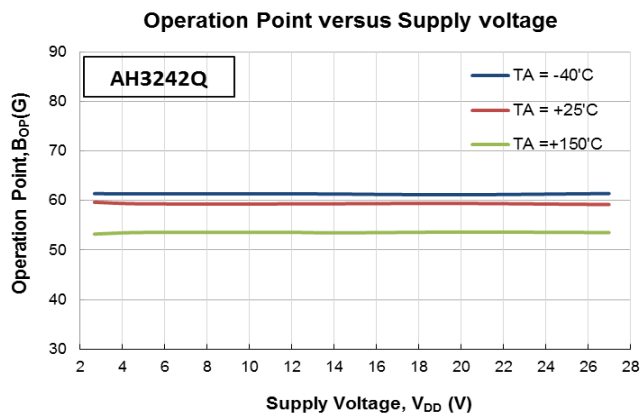
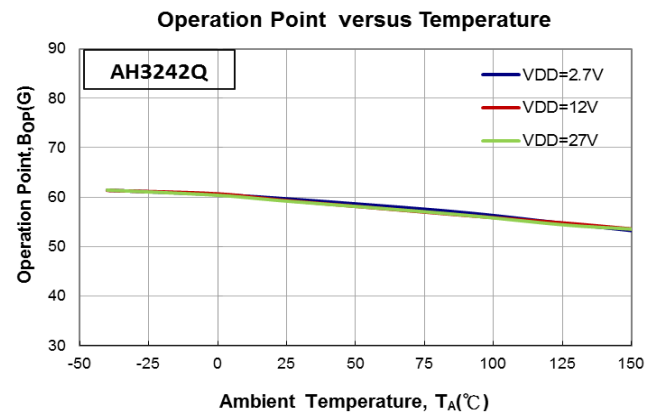
## Typical Operating Characteristics (cont.)

### AH3241Q Magnetic Characteristics Performance



## Typical Operating Characteristics (cont.)

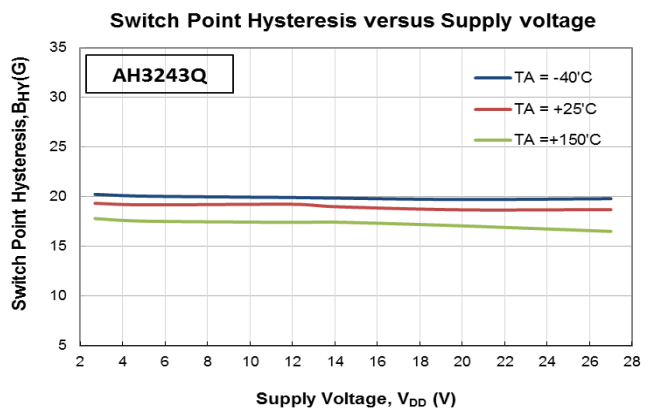
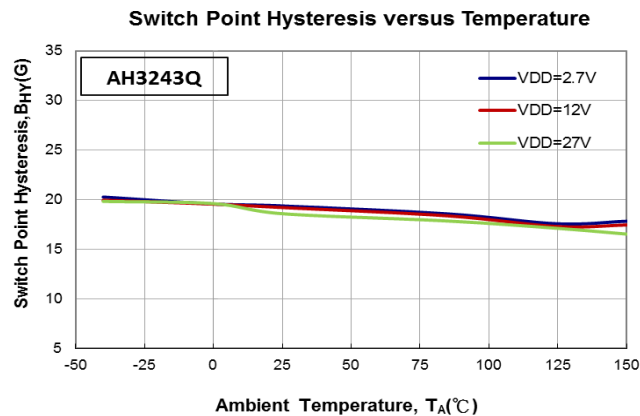
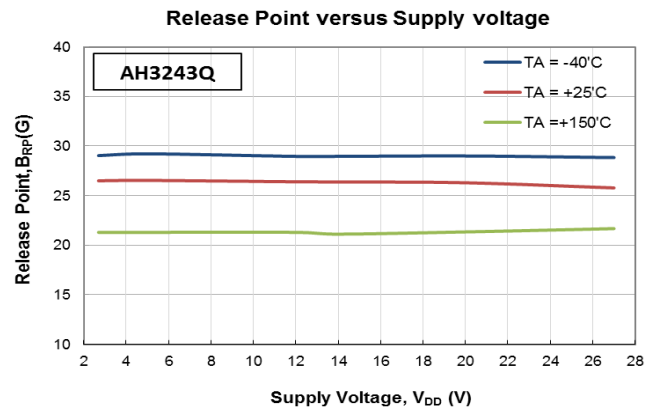
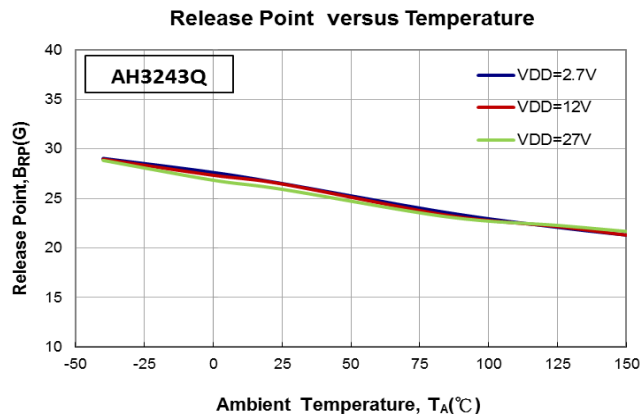
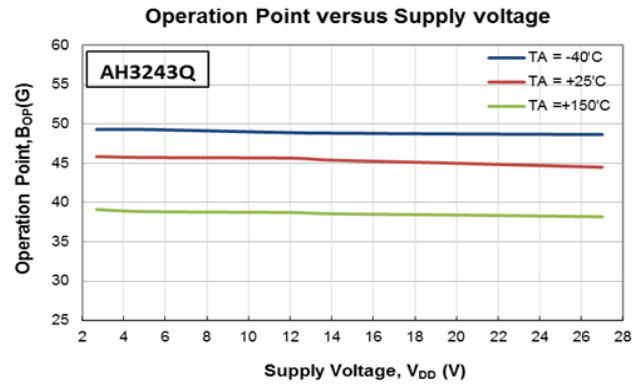
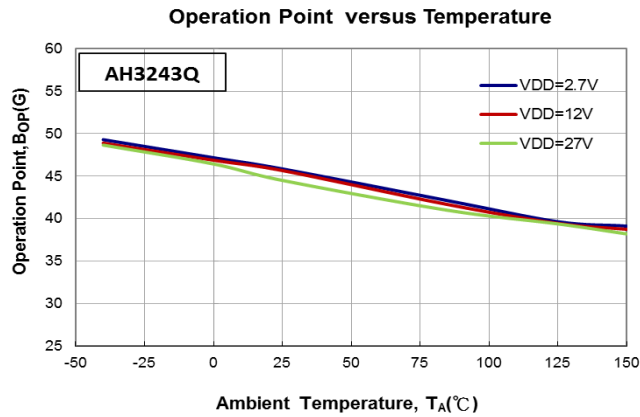
### AH3242Q Magnetic Characteristics Performance





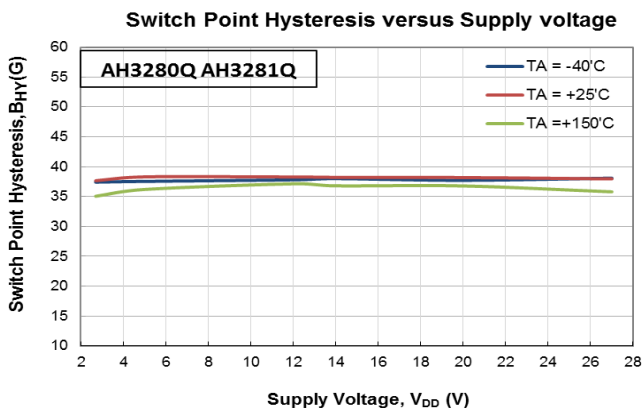
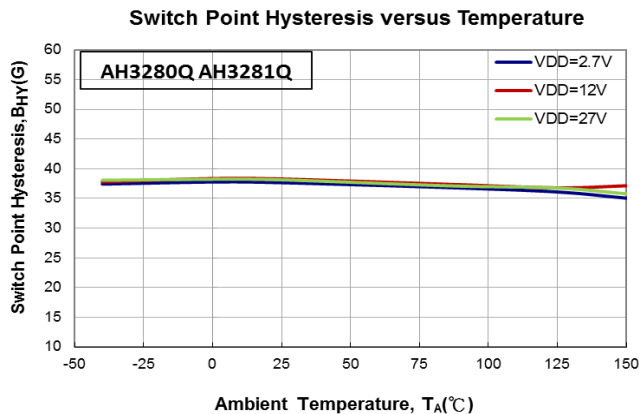
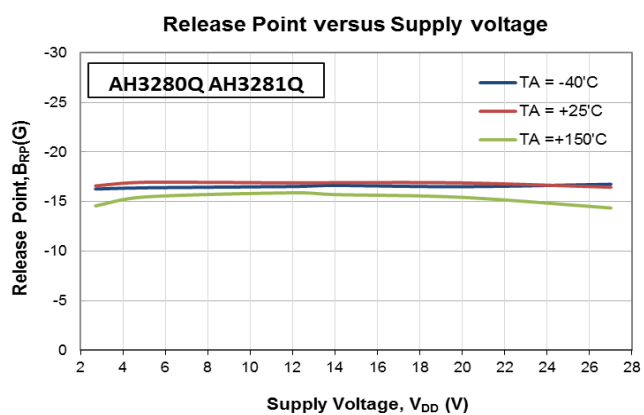
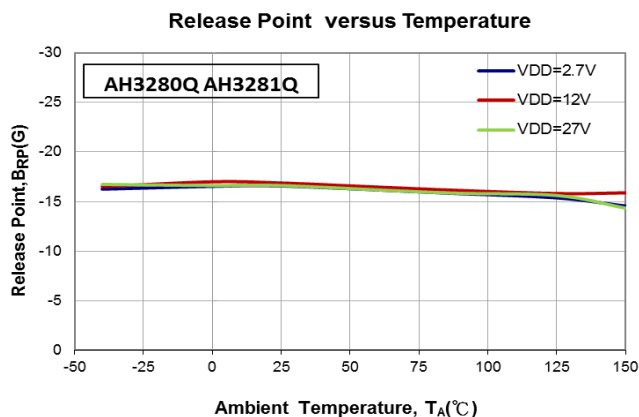
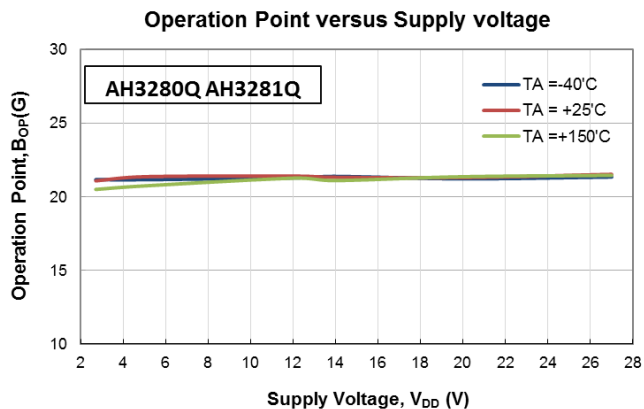
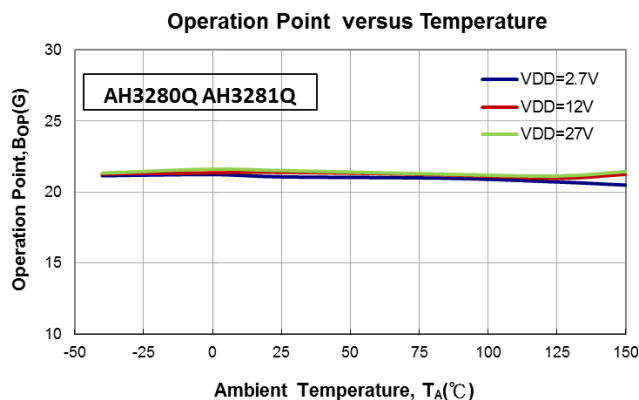
## Typical Operating Characteristics (cont.)

### H3243Q Magnetic Characteristics Performance



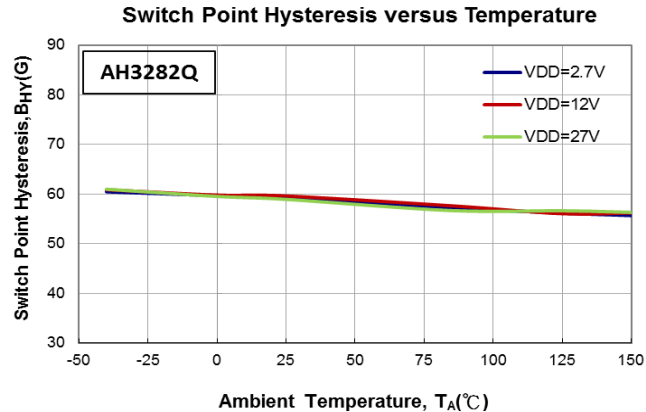
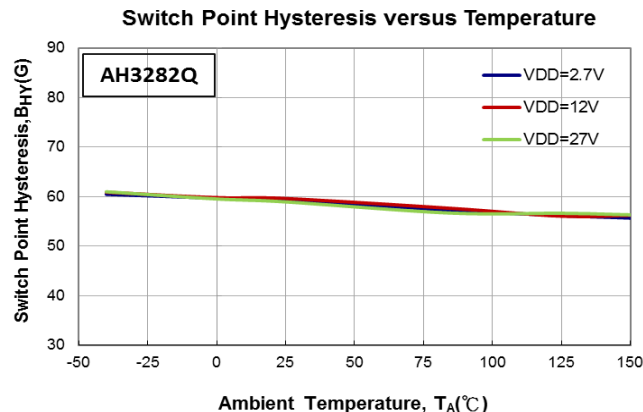
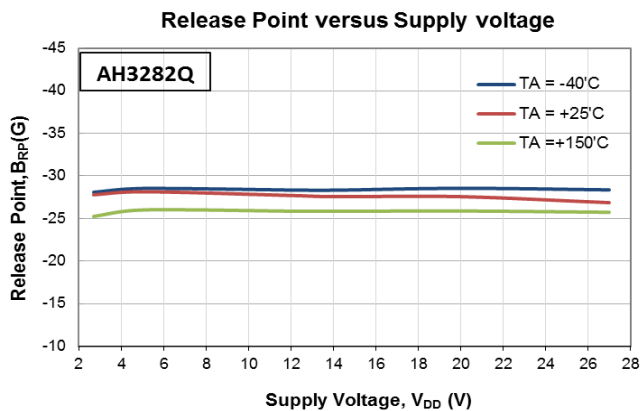
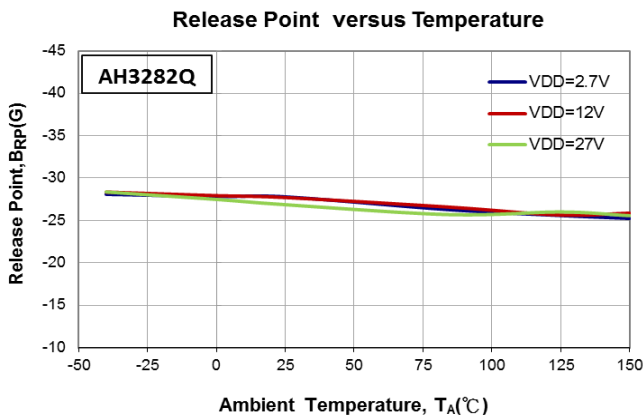
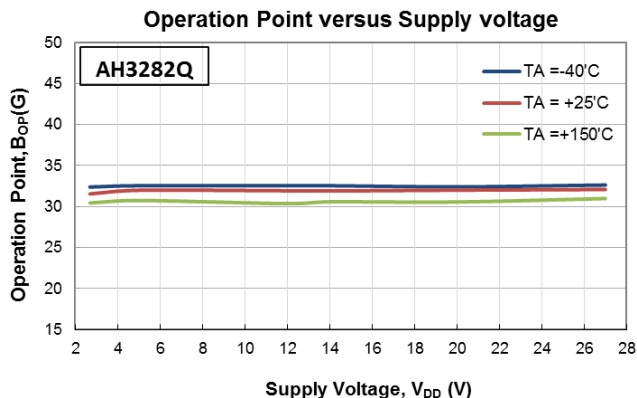
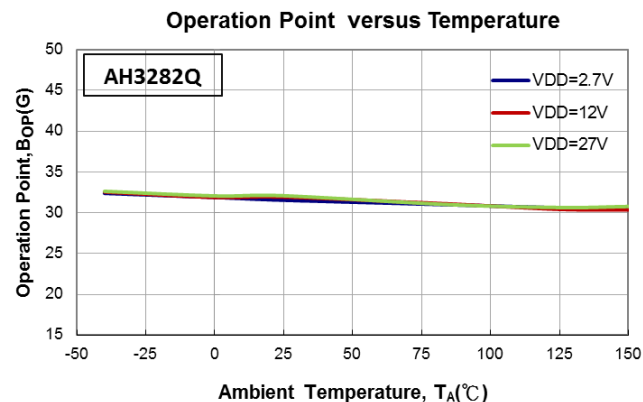
## Typical Operating Characteristics (cont.)

### AH3280Q\_AH3281Q Magnetic Characteristics Performance



## Typical Operating Characteristics (cont.)

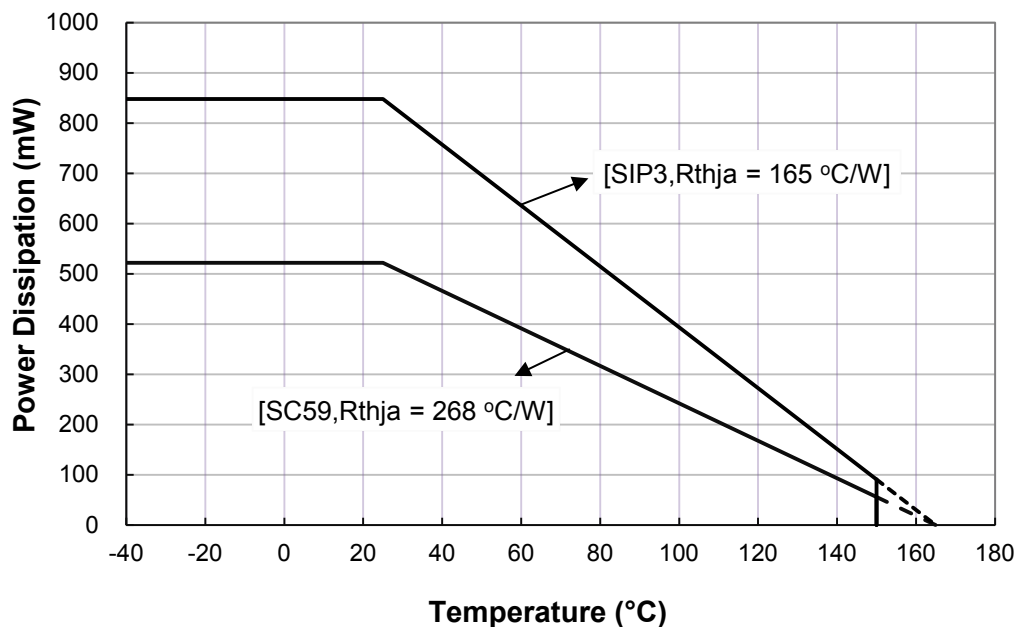
### AH3282Q Magnetic Characteristics Performance



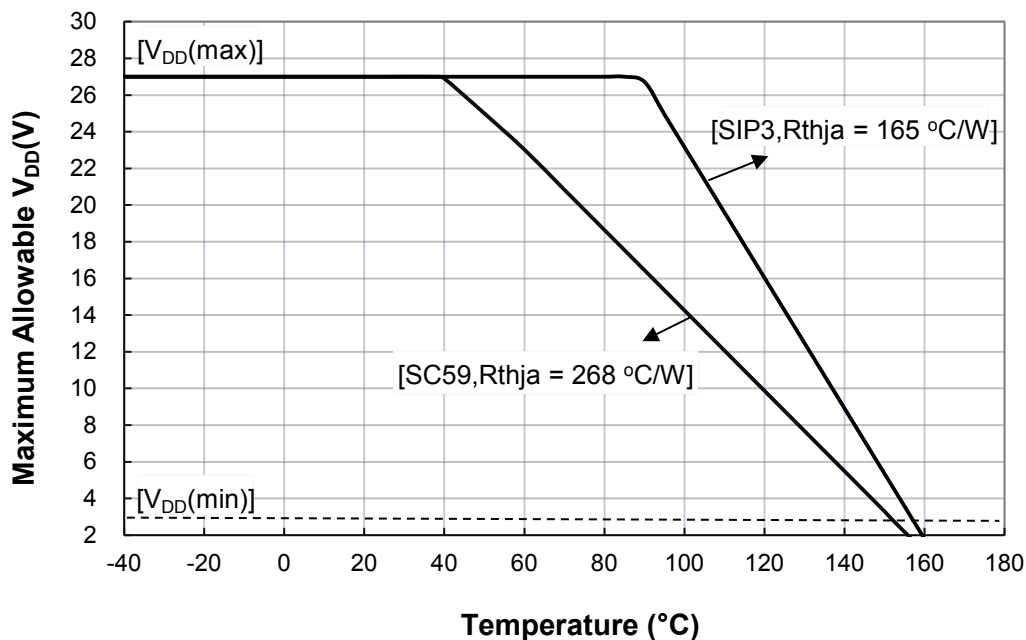
## Thermal Performance Characteristics

Symbol	Parameter	Conditions	Rating	Unit
$R_{\theta JA}$	Package Thermal Resistance	SC59, 50mm*50mm 2oz MRB PCB, single layer	268	°C/W
		SIP-3, 50mm*50mm 2oz MRB PCB, single layer	143	°C/W

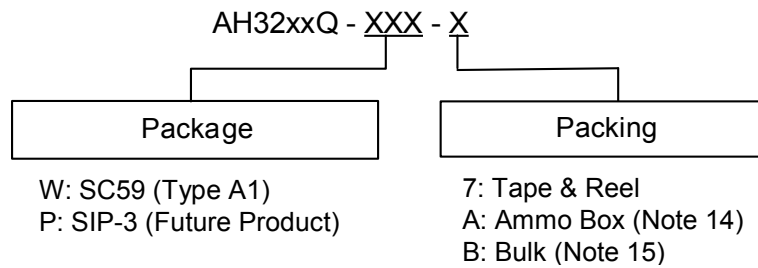
**Thermal Derating Curve vs. Ambient Temperature**



**Power Derating Curve**



## Ordering Information



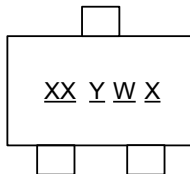
Part Number	Package Code	Packaging	Bulk Box		7" Tape and Reel		Ammo Box	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH3241Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3241Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3241Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3242Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3242Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3242Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3243Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3243Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3243Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3280Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3280Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3280Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3281Q-P-A	P	SIP-3 (Ammo Pack)	1000	-B	NA	NA	NA	NA
AH3281Q-P-B	P	SIP-3 (Bulk Pack)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3281Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA
AH3282Q-P-A	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH3282Q-P-B	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH3282Q-W-7	W	SC59 (Type A1)	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes: 14. Ammo Box is for SIP-3 (Ammo Pack) Spread Lead.  
 15. Bulk is for SIP-3 (Bulk Pack) Straight Lead.

## Marking Information

### (1) Package Type: SC59 (Type-A1)

( Top View )



XX : Identification code

Y : Year 0 to 9

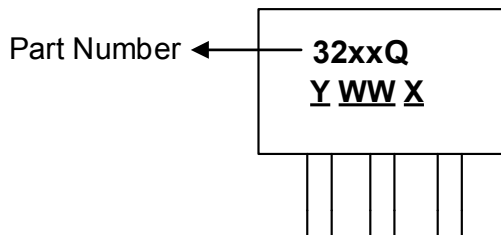
W : Week : A to Z : 1 to 26 week;  
a to z : 27 to 52 week; z represents  
52 and 53 week

X : Internal code

Part Number	Package	Identification Code
AH3241Q	SC59 (Type A1)	BR
AH3242Q	SC59 (Type A1)	BS
AH3243Q	SC59 (Type A1)	BT
AH3280Q	SC59 (Type A1)	BW
AH3281Q	SC59 (Type A1)	BU
AH3282Q	SC59 (Type A1)	BV

### (2) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

(Top View)



Y : Year : 0~9

WW : Week : 01~52, "52" represents  
52 and 53 week

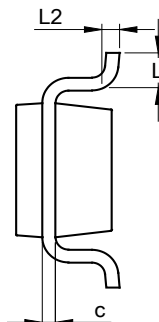
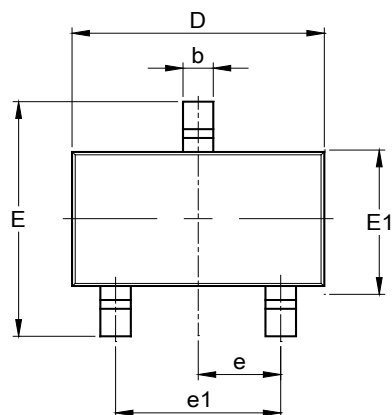
X : Internal Code

Part Number	Package	Identification Code
AH3241Q	SIP-3(Ammo Pack)	3241Q
AH3241Q	SIP-3 (Bulk Pack)	3241Q
AH3242Q	SIP-3(Ammo Pack)	3242Q
AH3242Q	SIP-3(Bulk Pack)	3242Q
AH3243Q	SIP-3(Ammo Pack)	3243Q
AH3243Q	SIP-3(Bulk Pack)	3243Q
AH3280Q	SIP-3(Ammo Pack)	3280Q
AH3280Q	SIP-3 (Bulk Pack)	3280Q
AH3281Q	SIP-3(Ammo Pack)	3281Q
AH3281Q	SIP-3 (Bulk Pack)	3281Q
AH3282Q	SIP-3 (Ammo Pack)	3282Q
AH3282Q	SIP-3 (Bulk Pack)	3282Q

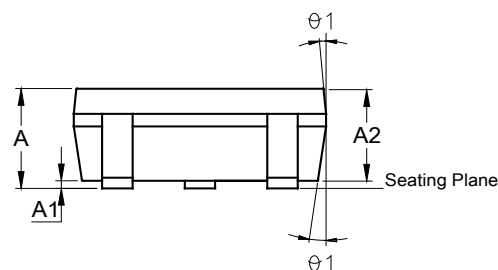
## Package Outline Dimensions (All dimensions in mm.)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

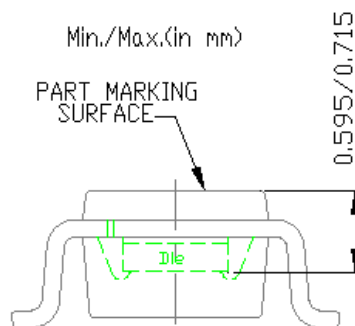
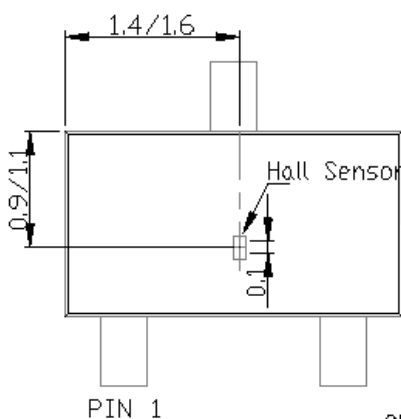
### (1) Package Type: SC59 (Type A1)



SC59 (Type A1)			
Dim	Min	Max	Typ
A	--	1.45	--
A1	0.00	0.15	--
A2	0.90	1.30	1.15
b	0.30	0.50	--
c	0.08	0.22	--
D	2.90 BSC		
E	2.80 BSC		
E1	1.60 BSC		
e	0.95 BSC		
e1	1.90 BSC		
L	0.30	0.60	0.45
L2	0.25 BSC		
θ1	5°	15°	10°
All Dimensions in mm			



AH32xxQ Hall sensor



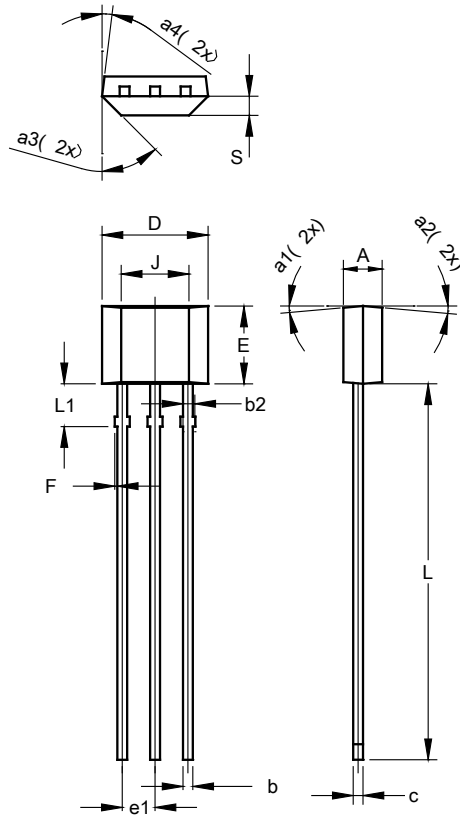
PIN 1

SENSOR LOCATION

## Package Outline Dimensions (Cont.) (All dimensions in mm.)

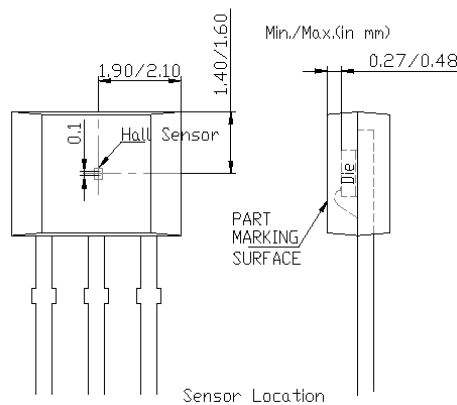
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (2) Package Type: SIP-3 (Bulk Pack)



SIP-3 (Bulk Pack)			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
b	0.33	0.43	0.38
b2	0.40	0.508	0.46
c	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
F	0.00	0.20	—
J	2.62 REF		
L	14.00	15.00	14.50
L1	1.55	1.75	1.65
S	0.63	0.84	0.74
a1	—	—	5°
a2	—	—	5°
a3	—	—	45°
a4	—	—	3°
All Dimensions in mm			

AH32xxQ SIP3 Hall sensor

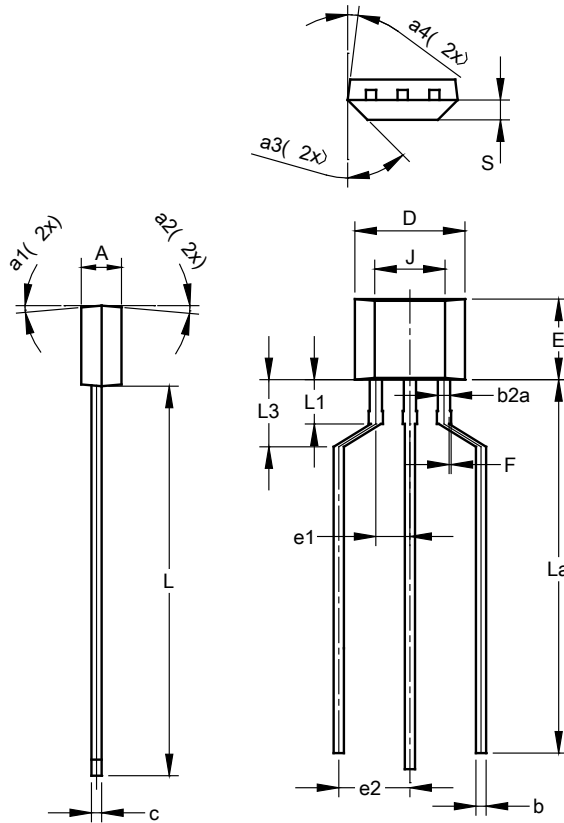




**Package Outline Dimensions** (Cont.) (All dimensions in mm.)

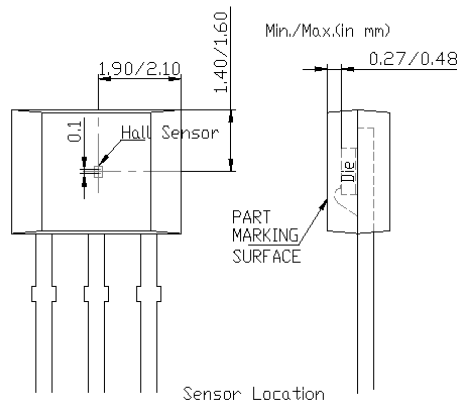
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**(3) Package Type: SIP-3 (Ammo Pack)**



SIP-3 (Ammo Pack)			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
b	0.33	0.43	0.38
b2a	0.40	0.52	0.46
c	0.35	0.41	0.38
D	3.90	4.30	4.10
E	2.80	3.20	3.00
e1	1.24	1.30	1.27
e2	2.40	2.90	2.65
F	0.00	0.20	—
J	2.62 REF		
L	14.00	15.00	14.50
La	12.90	14.90	13.90
L1	1.55	1.75	1.65
L3	2.00	3.00	2.50
S	0.63	0.84	0.74
a1	—	—	5°
a2	—	—	5°
a3	—	—	45°
a4	—	—	3°
All Dimensions in mm			

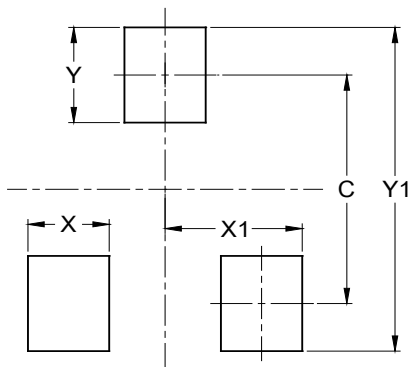
AH32xxQ SIP3 Hall sensor



## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### (1) Package Type: SC59 (Type A1)



Dimensions	Value (in mm)
C	2.40
X	0.80
X1	1.35
Y	1.00
Y1	3.40

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